

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0442480103](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Inverted, 6/6, 4 Ports

Documents:

3D Model	Product Specification PS-43860-003 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E107635

General

Product Family	Modular Jacks/Plugs
Series	44248
Component Type	PCB Jack
Magnetic	No
Overview	modular_plugs_jacks
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Name	RJ11

Physical

Boot Color	N/A
Color - Resin	Black
Durability (mating cycles max)	500
Flammability	94V-0
Inverted / Top Latch	Yes
Keying to Mating Part	None
Lightpipes/LEDs	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Orientation	Right Angle (Side Entry)
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.57 mm
Packaging Type	Tray
Panel Mount	Without Flange
Pitch - Mating Interface (in)	0.040 In
Pitch - Mating Interface (mm)	1.02 mm
Pitch - Term. Interface (in)	0.040 In
Pitch - Term. Interface (mm)	1.02 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Ports	4
Positions / Loaded Contacts	6/6
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Waterproof / Dustproof	No

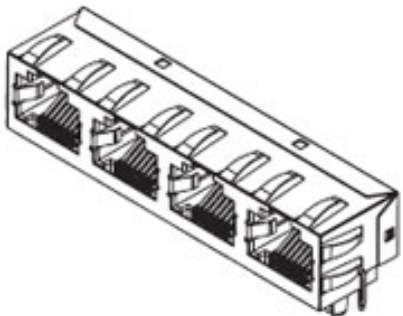


image - Reference only

Series

EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Contains SVHC: No
Halogen-Free
Status

China RoHS



Not Reviewed

**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series

[44248Series](#)

Mates With

[FCC 68 Plugs,](#)

Wire/Cable Type	N/A
Electrical	
Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Grounding to Panel	With All Panel Grounding Tab
Shielded	Yes
Voltage - Maximum	150V AC (RMS)
Solder Process Data	
Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-44248-004
Product Specification	PS-43860-003, RPS-43860-004, RPS-43860-007, RPS-43860-008, RPS-43860-013
Sales Drawing	SD-44248-001

This document was generated on 06/08/2010

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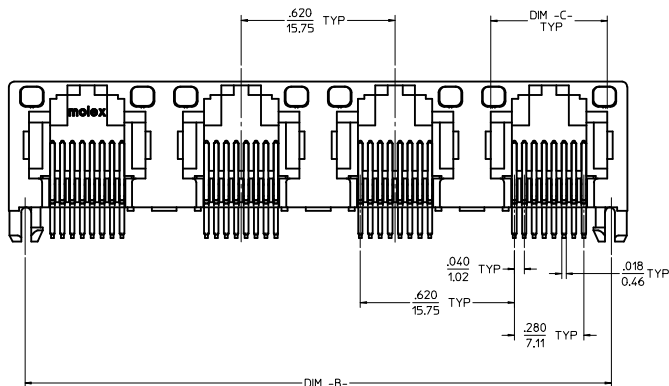
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8

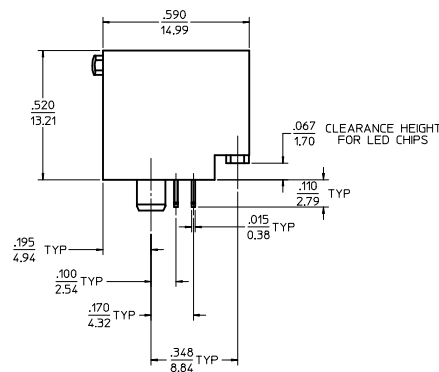


(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



UNSHIELDED
WITH LIGHT PIPES



8 CIRCUIT HOUSING(S)

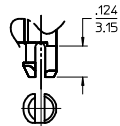
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0001	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0002	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0005	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0006	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0009	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0010	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0011	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0012	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0017	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0018	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0019	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0020	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

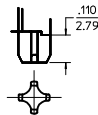
- NOTES:
1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
2) FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
5) APPLICATION SPECIFICATION: AS-43860-001
6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
8) MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

CHGNO 0117 TO 0119 EC NO: UCP2009-1482 DRAWN BY: KLOSTNER 2008/12/10 CHKD BY: IELL 2008/12/10 APPROVED BY: SMITH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
		mm	INCH	DRAWN BY MAYO	DATE 98/10/06	TITLE GANGED INVERTED MODJACK ASSEMBLY		
		4 PLACES ±---	±---	CHECKED BY ROBERTS	DATE 98/10/06	MOLEX INCORPORATED		
		3 PLACES ±---	±.010	APPROVED BY ROBERTS	DATE 98/10/06	DOCUMENT NO. SD-44248-001		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE D		SEE CHART		SHEET NO. 1 OF 6		



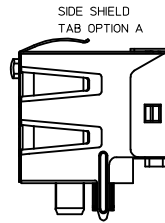
SNAP-FIT PEG OPTION

SCALE: NTS
SEE NOTE #8

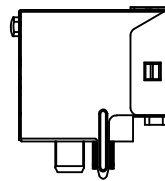


PRESS-FIT PEG OPTION

SCALE: NTS
SEE NOTE #8



SIDE SHIELD
TAB OPTION B



(8) CIRCUIT HOUSING(S)

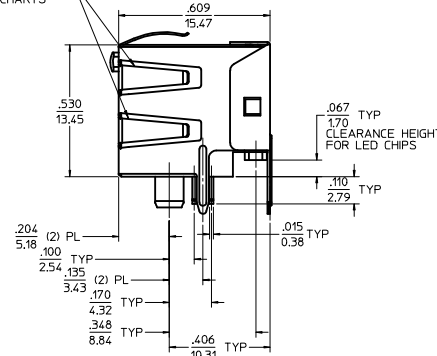
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0029	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0030	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
44248-0033	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0034	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0037	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0038	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0039	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0040	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0045	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0046	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0047	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0048	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

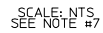
- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SHIELD:
*100 MICROINCHES (2.54 MICROMETERS) NICKEL OVER 50 MICROINCHES (1.27 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
 - APPLICATION SPECIFICATION: AS-43860-001
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

OPTIONAL SIDE
SHIELD TABS
SEE CHARTS



SHIELDED
WITH LIGHT PIPES

SEE SHEET 1 EC NO: UCP2009-1482 DRAWN: JALOSTER 2008/12/10 CHKD: BELL 2008/12/10 APPROV: SMITH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED):		DIMENSION STYLE		SCALE		DESIGN UNITS		THIRD ANGLE PROJECTION	
				IN/MM		4:1		INCH			
		mm INCH		DRAWN BY DATE		TITLE		GANGED INVERTED MODJACK ASSEMBLY		MOLEX INCORPORATED	
		4 PLACES ±.010		MAYO 98/10/06							
		3 PLACES ±.010		CHECKED BY DATE							
2 PLACES ±0.25		JROBERTS 98/10/06									
1 PLACE ±.010		APPROVED BY DATE		MOLEX							
		JROBERTS 98/10/06									
		ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.				SHEET NO.	
				SEE CHART		SD-44248-001				2 OF 6	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE D		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



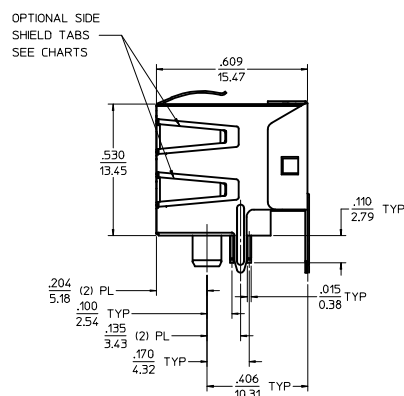
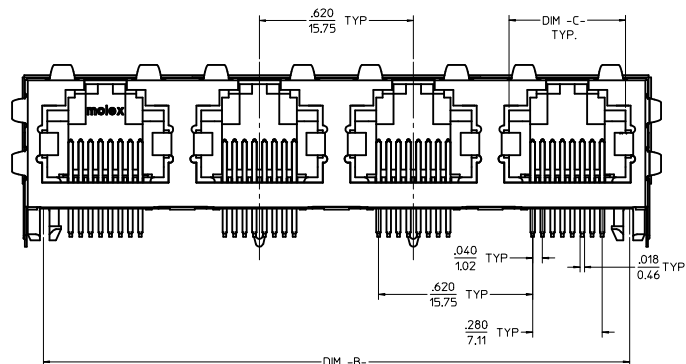
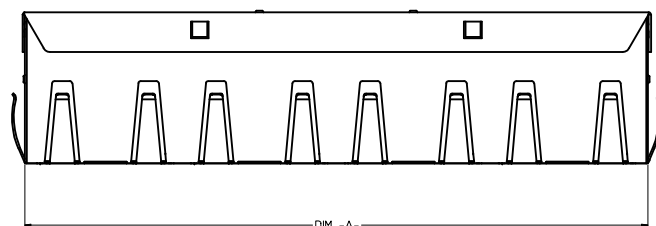
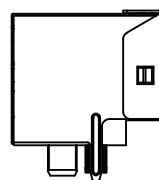
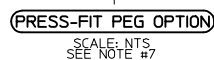
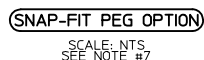
6 CIRCUIT HOUSING(S)						
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0065	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0066	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0067	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0068	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0073	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0074	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0075	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0076	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88



- NOTES:
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.,
* SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (254 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX 1 OF DIRECTIVE 2000/53/EC."
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-A3860-003.
 - 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
 - 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
CONFORMS TO FORMS FOR REGULATION PART 85X FOR MODULAR JACKS.
 - 7) MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 8) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

(UNSHIELDED)

SEE DETAIL 1 C4	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
				IN/MM	4:1	INCH	
	▽=0	.mm	.INCH	DRAWN BY	DATE	TITLE	
	▽=0	4 PLACES ± .001	± .001	MAYO	98/10/06	GANGED INVERTED MODJACK ASSEMBLY	
		3 PLACES ± .010	± .010	CHECKED BY	DATE		
		2 PLACES ± 0.25	± .010	JROBERTS	98/10/06		
REV	DESCRIPTION	1 PLACE ± .010		APPROVED BY	DATE	MOLEX INCORPORATED	
		ANGULAR ± 1/2°		JROBERTS	98/10/06		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.	
				SEE CHART		SD-44248-001	
				SHEET NO.	3 OF 6		
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



(8) CIRCUIT HOUSING(S)								
X = NOT TOOLED	ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
	44248-0085	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0086	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
	44248-0089	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0090	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
X	44248-0119	8	4	PRESS FIT	B	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
42248-0093	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0094	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0095	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0096	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0101	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0102	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0103	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0104	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

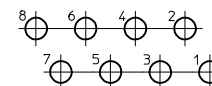
- NOTES:
- 1) MATERIAL:
 - HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
 - TERMINALS: PHOSPHOR BRONZE
 - SHIELD: BRASS
 - 2) FINISH:
 - TERMINALS:
 - SELECT GOLD IN CONTACT AREA: 50 MICRONS (127 MICROMETERS) MIN.
 - SELECT TIN IN PCB TAIL AREA: 100 MICRONS (254 MICROMETERS) MIN.
 - WITH OVERALL NICKEL UNDERPLATE: 50 MICRONS (127 MICROMETERS) MIN.
 - SHIELD:
 - 100 MICRONS (254 MICROMETERS) NICKEL OVER 50 MICRONS (127 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
 - THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS DIRECTIVE 2002/95/EC AND ELV ANNEX I OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PCB TAILS AVOIDER SHIELD
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - 4) PACKAGING SPECIFICATION:
 - CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-42248-004.
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - 7) MOD JACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
 - THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 8) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5 AND 6).
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-49-002.

(SHIELDED)

CHGD 0117 TO 0119 EC NO. IJC2003-1482 DRAWING KLOSTENLER 2008/12/10 CHYKJ-BELL 2008/12/10 APPR: FSNH 2008/12/10	QUALITY SYMBOLS  = 0  = 0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± .025 ± --- 1 PLACE ± ± --- ANGULAR ±1/2°	DIMENSION STYLE IN/MM DRAWN BY MMYAO 98/10/06 CHECKED BY DATE JOBERTS 98/10/06 APPROVED BY DATE JOBERTS 98/10/06	SCALE 4:1 TITLE GANGED INVERTED MODJACK ASSEMBLY	DESIGN UNITS INCH THIRD ANGLE PROJECTION
DESCRIPTION DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO. SEE CHART	DOCUMENT NO. SD-44248-001	SHEET NO. 4 OF 6
REV			SIZE 	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



TYPICAL PC TERMINAL HOLE LAYOUT
(8) CIRCUIT CONFIGURATION
SCALE: 10:1

NOTES:

- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH THE SHIELDING OPTION INCLUDED
- 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
- 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 REC NO: UCP2009-1482 DRAWING: MOLEX EMI EBR 2008/12/10 CHKD: BELL APPR: F-SHILL 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
	▽=0 ▽=0	mm	INCH	DRAWN BY	DATE	TITLE	4:1	INCH		
		4 PLACES ±.005	MMAYO	98/10/06	GANGED INVERTED MODJACK ASSEMBLY					
		3 PLACES ±.010	CHECKED BY	DATE						
		2 PLACES ±.025	JROBERTS	98/10/06	MOLEX MOLEX INCORPORATED					
		1 PLACE ±.050	APPROVED BY	DATE						
		ANGULAR ±1/2°	JROBERTS	98/10/06	MATERIAL NO.		DOCUMENT NO.	SHEET NO.		
			N/A		SD-44248-001		5 OF 6			
	REV	DESCRIPTION	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							
			SIZE D THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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